Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: <u>ti.com/support</u>

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: **06/09/2022** 

### Details for "TLV71328PDBVT"

### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
TLV71328PDBVT	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DBV   5	2.9x1.6x1.45	18.2

#### \*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

### **Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

## **Component Information**

				Homoge	neous Material Level	Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire	•	•			·	•	
Precious Metals	Gold	7440-57-5	0.038374	100	1000000	0.210612	2106
Sub-Total			0.038374	100	1000000	0.210612	2106
Die Attach Adhesive			-				
Precious Metals	Silver	7440-22-4	0.034702	79.999078	799991	0.190459	1905
Thermoplastics	Ероху	85954-11-6	0.008676	20.000922	200009	0.047617	476
Sub-Total			0.043378	100	1000000	0.238077	2381
Lead Frame			-	_			
Copper and Its Alloys	Copper	7440-50-8	6.290748	97.38	973800	34.526242	345262
Copper and Its Alloys	Iron	7439-89-6	0.153748	2.38	23800	0.843833	8438
Copper and Its Alloys	Phosphorus	7723-14-0	0.005426	0.083994	840	0.02978	298
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.001938	0.03	300	0.010637	106
Zinc and Its Alloys	Zinc	7440-66-6	0.00814	0.126006	1260	0.044676	447
Sub-Total			6.46	100	1000000	35.455168	354552
Lead Frame Plating		-					
Nickel and Its Alloys	Nickel	7440-02-0	0.110339	95.119828	951198	0.605586	6056
Precious Metals	Gold	7440-57-5	0.000905	0.780172	7802	0.004967	50
Precious Metals	Palladium	7440-05-3	0.004756	4.1	41000	0.026103	261
Sub-Total			0.116	100	1000000	0.636656	6367
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	9.862749	85.999998	860000	54.13087	541309
Other Plastics and Rubber	Carbon Black	1333-86-4	0.057342	0.500004	5000	0.314717	3147
Thermoplastics	Ероху	85954-11-6	1.548222	13.499998	135000	8.497286	84973
Sub-Total			11.468313	100	1000000	62.942873	629429
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.094128	100	1000000	0.516614	5166
Sub-Total			0.094128	100	1000000	0.516614	5166
Total			18.220193			100	1000000

## Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The page calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average concentration values.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

# Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# **Product Content Methodology**

For an explanation of the methods used to determine material weights, See Product Content Methodology

# **Material Declaration Certificate for Semiconductor IC Packaged Products**

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

# Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/09/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.